

VOLTAGE DETECTORS

FEATURES

- Qualified for Automotive Applications
- Single Voltage Detector (TPS3803): Adjustable/1.5 V
- Dual Voltage Detector (TPS3805): Adjustable/3.3 V
- High ±1.5% Threshold Voltage Accuracy
- Supply Current: 3 μA Typical at V_{DD} = 3.3 V
- Push/Pull Reset Output (TPS3805),
 Open-Drain Reset Output (TPS3803)
- Temperature Range: –40°C to 125°C
- 5-Pin SC-70 Package

DESCRIPTION

The TPS3803 and TPS3805 families of supervisory circuits provide circuit initialization and timing supervision, primarily for DSPs and processor-based systems.

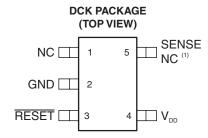
The TPS3803G15 device has a fixed-sense threshold voltage $V_{\rm IT}$ set by an internal voltage divider, whereas the TPS3803-01 has an adjustable SENSE input that can be configured by two external resistors. In addition to the fixed sense threshold monitored at $V_{\rm DD}$, the TPS3805 devices provide a second adjustable SENSE input. RESET is asserted in case either of the two voltages drops below $V_{\rm IT}$.

During power on, \overline{RESET} is asserted when supply voltage V_{DD} becomes higher than 0.8 V. Thereafter, the supervisory circuit monitors V_{DD} (and/or SENSE) and keeps \overline{RESET} active as long as V_{DD} or SENSE remains below the threshold voltage V_{IT} . As soon as V_{DD} (SENSE) rises above the threshold voltage V_{IT} , \overline{RESET} is deasserted again. The product spectrum is designed for 1.5 V, 3.3 V, and adjustable supply voltages.

The devices are available in a 5-pin SC-70 package. The TPS3803 and TPS3805 devices are characterized for operation over a temperature range of -40°C to 125°C.

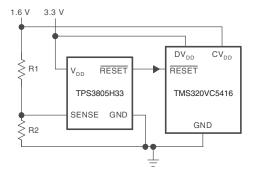
APPLICATIONS

- Applications Using DSPs, Microcontrollers, or Microprocessors
- Wireless Communication Systems
- Portable/Battery-Powered Equipment
- Programmable Controls
- Intelligent Instruments
- Industrial Equipment
- Notebook/Desktop Computers
- Automotive Systems



NC - No connection

(1) SENSE on TPS3803-01, TPS3805H33 NC on TPS3803G15





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





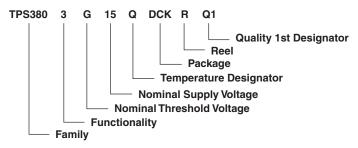
This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION(1)

-	THRESHOLD VOLTAGE		PACKAGE ⁽²⁾		ORDERABLE PART	TOP-SIDE
T _A	V _{DD}	SENSE	PACKAGE		NUMBER	MARKING
	NA	1.226 V			TPS3803-01QDCKRQ1	AWJ
-40°C to 125°C	1.4 V	NA	SC-70 - DCK	Reel of 3000	TPS3803G15QDCKRQ1	AXU
	3.05 V	1.226 V			TPS3805H33QDCKRQ1	AWZ

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
- (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



FUNCTION/TRUTH TABLE

TPS3803-01		
SENSE > V _{IT}	RESET	
0	L	
1	Н	

FUNCTION/TRUTH TABLE

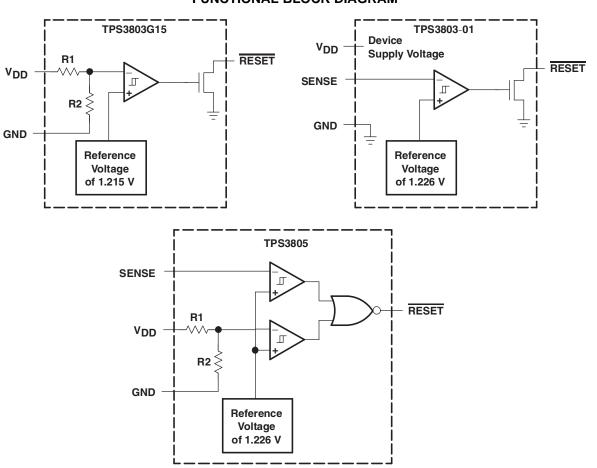
TPS3803G15		
$V_{DD} > V_{IT}$	RESET	
0	L	
1	Н	

FUNCTION/TRUTH TABLE

	TPS3805H33	
$V_{DD} > V_{IT}$	SENSE > V _{IT}	RESET
0	0	L
0	1	L
1	0	L
1	1	Н

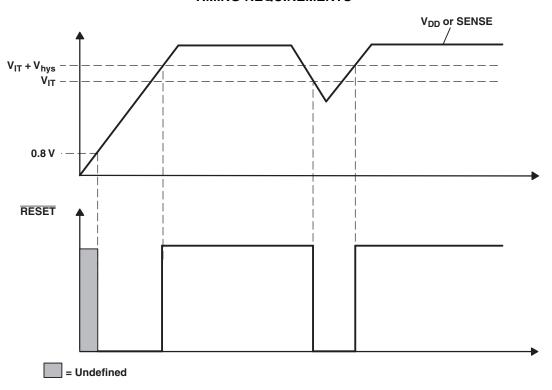


FUNCTIONAL BLOCK DIAGRAM





TIMING REQUIREMENTS



TERMINAL FUNCTIONS

TERMINAL		1/0	DESCRIPTION	
NAME	NO.	I/O	DESCRIPTION	
GND	2	I	Ground	
RESET	3	0	Active-low reset output (TPS3803: open drain, TPS3805: push/pull)	
SENSE	5	I	Adjustable sense input	
NC	1		No internal connection	
NC (TPS3803G15)	5		No internal connection	
V_{DD}	4	I	Input supply voltage, fixed sense input for TPS3803G15 and TPS3805	



ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

			VALUE
V_{DD}	Supply voltage ⁽²⁾		7 V
	Voltage applied to all other pins (2)	–0.3 V to 7 V	
I _{OL}	Maximum low-level output current		5 mA
I _{OH}	Maximum high-level output current		–5 mA
I _{IK}	Input clamp current $V_I < 0$ or $V_I > V_{DD}$		±10 mA
I _{OK}	Output clamp current	$V_O < 0$ or $V_O > V_{DD}$	±10 mA
P _D	Continuous total power dissipation		See Dissipation Rating Table
T _A	Operating free-air temperature range		-40°C to 125°C
T _{stg}	Storage temperature range		−65°C to 150°C
T _{solder}	Soldering temperature		260°C

⁽¹⁾ Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATINGS

PACKAGE	POWER RATING	DERATING FACTOR	POWER RATING	POWER RATING
	T _A < 25°C	ABOVE T _A = 25°C	T _A = 70°C	T _A = 85°C
DCK	321 mW	2.6 mW/°C	206 mW	167 mW

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
V_{DD}	Supply voltage	1.3	6	V
VI	Input voltage	0	$V_{DD} + 0.3$	V
T_A	Operating free-air temperature	-40	125	°C

⁽²⁾ All voltage values are with respect to GND. For reliable operation, the device should not be continuously operated at 7 V for more than t = 1000 h.



ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

	PARAM	ETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
			$V_{DD} = 1.5 \text{ V}, I_{OH} = -0.5 \text{ mA}$				
V_{OH}	High-level output voltag	e (TPS3805 only)	$V_{DD} = 3.3 \text{ V}, I_{OH} = -1 \text{ mA}$	$0.8 \times V_{DD}$			V
			$V_{DD} = 6 \text{ V}, I_{OH} = -1.5 \text{ mA}$				
			V _{DD} = 1.5 V, I _{OL} = 1 mA				
V_{OL}	Low-level output voltage	е	$V_{DD} = 3.3 \text{ V}, I_{OL} = 2 \text{ mA}$			0.3	V
			$V_{DD} = 6 \text{ V}, I_{OL} = 3 \text{ mA}$				
	Power-up reset voltage ⁽¹⁾		$V_{IT} > 1.5 \text{ V}, T_A = 25^{\circ}\text{C}$	0.8			V
	Power-up reset voltage	()	$V_{IT} \le 1.5 \text{ V}, T_A = 25^{\circ}\text{C}$	1			V
		SENSE		1.2	1.226	1.244	
V_{IT}	, Negative-going input threshold voltage (2)	TPS3803G15		1.379	1.4	1.421	V
	unconoid voltage	TPS3805H33		3.004	3.05	3.096	
.,	Dhartana da	1	1.2 V < V _{IT} < 2.5 V		15		
V_{hys}	Hysteresis		2.5 V < V _{IT} < 3.5 V		30		mV
I	Input current	SENSE		-25		25	nA
I _{OH}	High-level output current at RESET	Open drain only	V _{DD} = V _{IT} + 0.2 V, V _{OH} = V _{DD}			300	nA
		TPS3803-01	V 00V 0 · ·		2	4	
	I _{DD} Supply current	TPS3805, TPS3803G15	V _{DD} = 3.3 V, Output unconnected		3	5	
I _{DD}		TPS3803-01	V 0 V 0 de		2	4	μΑ
		TPS3805, TPS3803G15	V _{DD} = 6 V, Output unconnected		4	6	
C _I	Input capacitance	1	$V_I = 0 V \text{ to } V_{DD}$		1		pF

TIMING REQUIREMENTS

 R_L = 1 MΩ, C_L = 50 pF, T_A = $-40^{\circ}C$ to 125°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT	
	Pulse duration	V_{DD}	V - 105 x V V - 0.05 x V	.		5
ι _W	ruise duration	SENSE	$V_{IH} = 1.05 \times V_{IT}, V_{IL} = 0.95 \times V_{IT}$	5.5		μs

SWITCHING CHARACTERISTICS

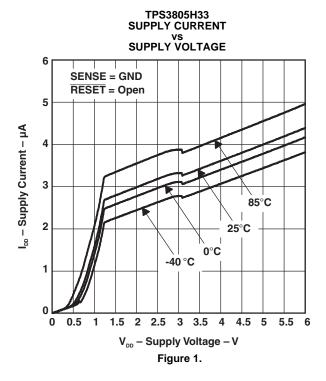
 R_L = 1 MΩ, C_L = 50 pF, T_A = $-40^{\circ}C$ to 125°C (unless otherwise noted)

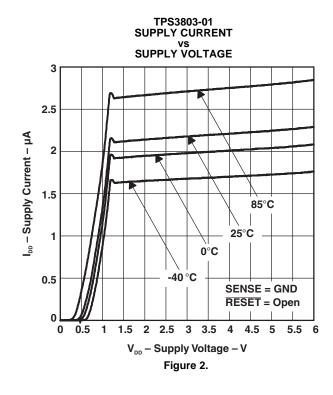
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
t _{PHL}	Propagation (delay) time, high-to-low-level output	V _{DD} to RESET delay SENSE to RESET delay	$V_{IH} = 1.05 \times V_{IT}, V_{IL} = 0.95 \times V_{IT}$		5	100	μs
t _{PLH}	Propagation (delay) time, low-to-high-level output	V _{DD} to RESET delay SENSE to RESET delay	$V_{IH} = 1.05 \times V_{IT}, V_{IL} = 0.95 \times V_{IT}$		5	100	μs

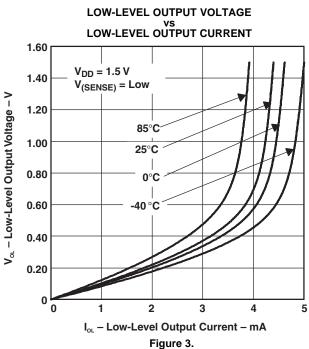
⁽¹⁾ The lowest supply voltage at which $\overline{\text{RESET}}$ ($V_{OL}(\text{max}) = 0.2 \text{ V}$, $I_{OL} = 50 \text{ }\mu\text{A}$) becomes active. $t_r(V_{DD}) \ge 15 \text{ }\mu\text{s/V}$. (2) To ensure the best stability of the threshold voltage, place a bypass capacitor (ceramic, 0.1 μF) near the supply terminals.

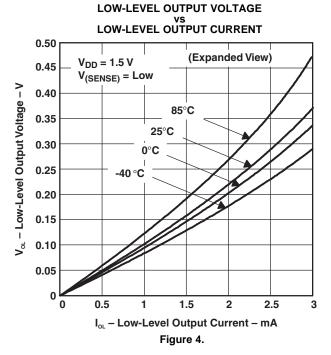


TYPICAL CHARACTERISTICS



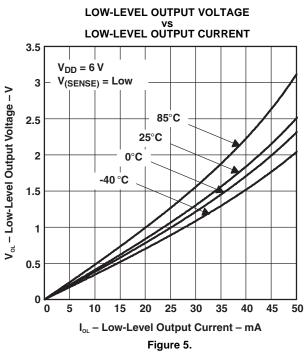








TYPICAL CHARACTERISTICS (continued)



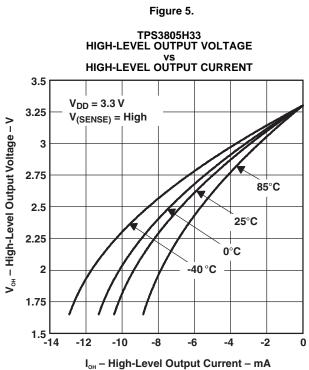
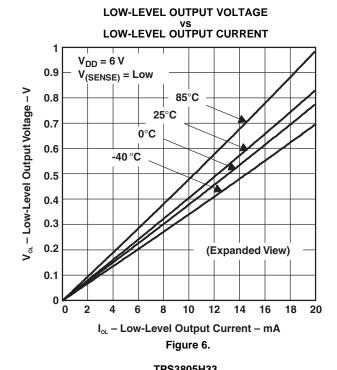
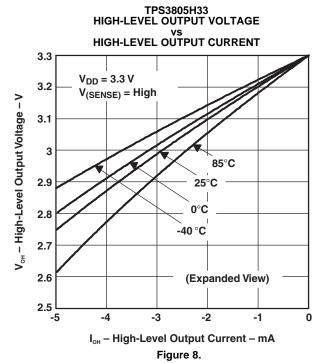


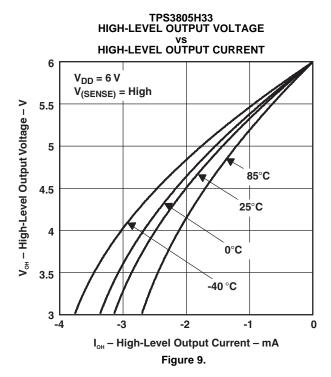
Figure 7.



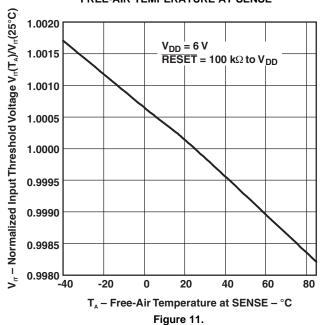




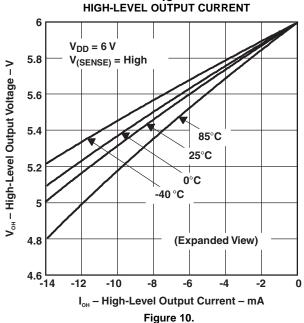
TYPICAL CHARACTERISTICS (continued)







TPS3805H33 HIGH-LEVEL OUTPUT VOLTAGE VS HIGH-LEVEL OUTPUT CURRENT



MINIMUM PULSE DURATION AT V_{DD}

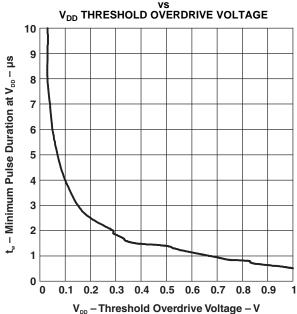
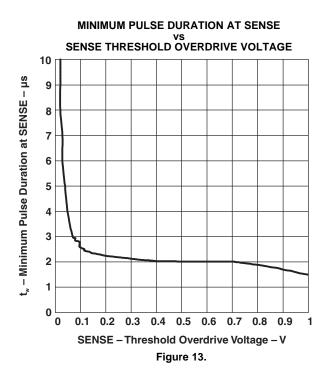
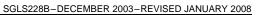


Figure 12.



TYPICAL CHARACTERISTICS (continued)







Revision History

REVISION	PAGE ⁽¹⁾	DESCRIPTION
SGLS228		Initial release
001 00004	1	Update features and description
SGLS228A	3	Update functional block diagram
SGLS228B	1	Update features

⁽¹⁾ Page numbers for previous revitions may differ from page numbers in the current version.





26-Jun-2014

PACKAGING INFORMATION

	_										
Orderable Device	Status	Package Type	_	Pins	_	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
2T03-01QDCKRG4Q1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AWJ	Samples
2T03G15QDCKRG4Q	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AXU	Samples
2T05H33QDCKRG4Q	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AWZ	Samples
TPS3803-01QDCKRQ1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AWJ	Samples
TPS3803G15QDCKRQ1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AXU	Samples
TPS3805H33QDCKRQ1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AWZ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



PACKAGE OPTION ADDENDUM

26-Jun-2014

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TPS3803-01-Q1, TPS3803G15-Q1, TPS3805H33-Q1:

- Catalog: TPS3803-01, TPS3803G15, TPS3805H33
- Enhanced Product: TPS3803-01-EP, TPS3803G15-EP, TPS3805H33-EP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 18-Aug-2014

TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

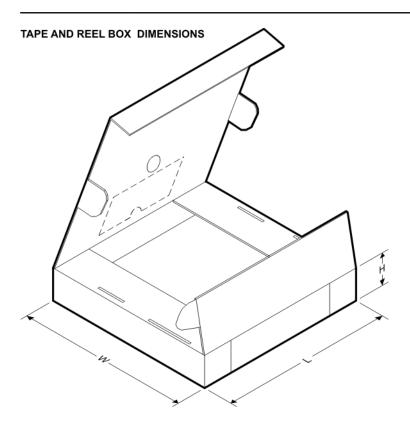
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS3803G15QDCKRQ1	SC70	DCK	5	3000	180.0	8.4	2.47	2.3	1.25	4.0	8.0	Q3

www.ti.com 18-Aug-2014

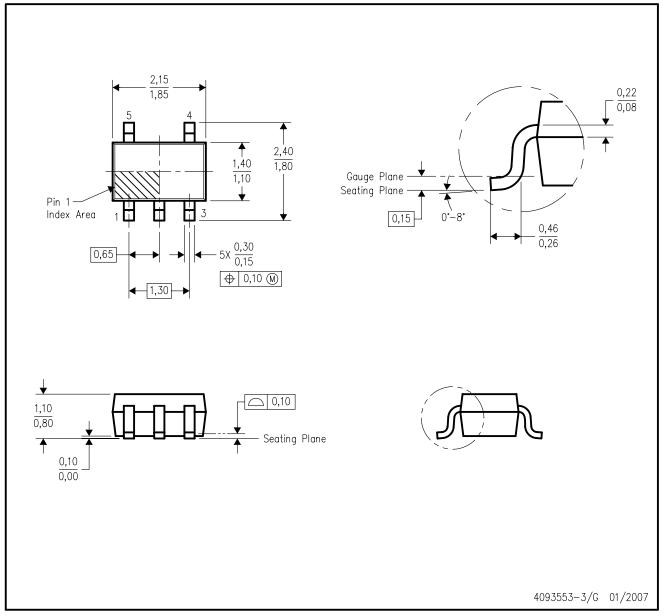


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
TPS3803G15QDCKRQ1	SC70	DCK	5	3000	202.0	201.0	28.0	

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



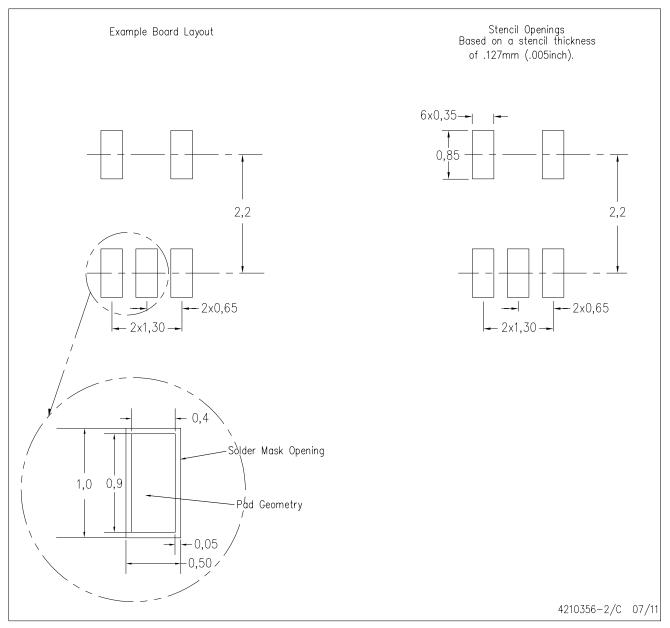
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Communications and Telecom Amplifiers amplifier.ti.com www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps

DSP **Energy and Lighting** dsp.ti.com www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers <u>microcontroller.ti.com</u> Video and Imaging <u>www.ti.com/video</u>

RFID <u>www.ti-rfid.com</u>

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com/omap

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>

AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com